

SN54ABT16500B, SN74ABT16500B 18-BIT UNIVERSAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS057G – DECEMBER 1990 – REVISED MAY 1997

- Members of the Texas Instruments *Widebus™* Family
- State-of-the-Art *EPIC-II B™* BiCMOS Design Significantly Reduces Power Dissipation
- *UBT™* (Universal Bus Transceiver) Combines D-Type Latches and D-Type Flip-Flops for Operation in Transparent, Latched, or Clocked Mode
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical V_{OLP} (Output Ground Bounce) < 0.8 V at $V_{CC} = 5$ V, $T_A = 25^\circ\text{C}$
- High-Impedance State During Power Up and Power Down
- Flow-Through Architecture Optimizes PCB Layout
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings

description

These 18-bit universal bus transceivers combine D-type latches and D-type flip-flops to allow data flow in transparent, latched, and clocked modes.

Data flow in each direction is controlled by output-enable ($\overline{\text{OEAB}}$ and $\overline{\text{OEBA}}$), latch-enable ($\overline{\text{LEAB}}$ and $\overline{\text{LEBA}}$), and clock ($\overline{\text{CLKAB}}$ and $\overline{\text{CLKBA}}$) inputs. For A-to-B data flow, the device operates in the transparent mode when $\overline{\text{LEAB}}$ is high. When $\overline{\text{LEAB}}$ is low, the A data is latched if $\overline{\text{CLKAB}}$ is held at a high or low logic level. If $\overline{\text{LEAB}}$ is low, the A data is stored in the latch/flip-flop on the high-to-low transition of $\overline{\text{CLKAB}}$. $\overline{\text{OEAB}}$ is active-high. When $\overline{\text{OEAB}}$ is high, the outputs are active. When $\overline{\text{OEAB}}$ is low, the outputs are in the high-impedance state.

Data flow for B to A is similar to that of A to B but uses $\overline{\text{OEBA}}$, $\overline{\text{LEBA}}$, and $\overline{\text{CLKBA}}$. The output enables are complementary ($\overline{\text{OEAB}}$ is active high and $\overline{\text{OEBA}}$ is active low).

SN54ABT16500B . . . WD PACKAGE
SN74ABT16500B . . . DGG OR DL PACKAGE
(TOP VIEW)

OEAB	1	56	GND
LEAB	2	55	CLKAB
A1	3	54	B1
GND	4	53	GND
A2	5	52	B2
A3	6	51	B3
V _{CC}	7	50	V _{CC}
A4	8	49	B4
A5	9	48	B5
A6	10	47	B6
GND	11	46	GND
A7	12	45	B7
A8	13	44	B8
A9	14	43	B9
A10	15	42	B10
A11	16	41	B11
A12	17	40	B12
GND	18	39	GND
A13	19	38	B13
A14	20	37	B14
A15	21	36	B15
V _{CC}	22	35	V _{CC}
A16	23	34	B16
A17	24	33	B17
GND	25	32	GND
A18	26	31	B18
OEBA	27	30	CLKBA
LEBA	28	29	GND



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description (continued)

When V_{CC} is between 0 and 2.1 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 2.1 V, $\overline{OE}$ should be tied to V_{CC} through a pullup resistor and OE should be tied to GND through a pulldown resistor; the minimum value of the resistor is determined by the current-sinking/current-sourcing capability of the driver.

The SN54ABT16500B is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74ABT16500B is characterized for operation from -40°C to 85°C .

FUNCTION TABLE[†]

INPUTS				OUTPUT
OEAB	LEAB	CLKAB	A	B
L	X	X	X	Z
H	H	X	L	L
H	H	X	H	H
H	L	↓	L	L
H	L	↓	H	H
H	L	H	X	B ₀ [‡]
H	L	L	X	B ₀ [§]

[†] A-to-B data flow is shown: B-to-A flow is similar but uses $\overline{OEBA}$, $\overline{LEBA}$, and $\overline{CLKBA}$.

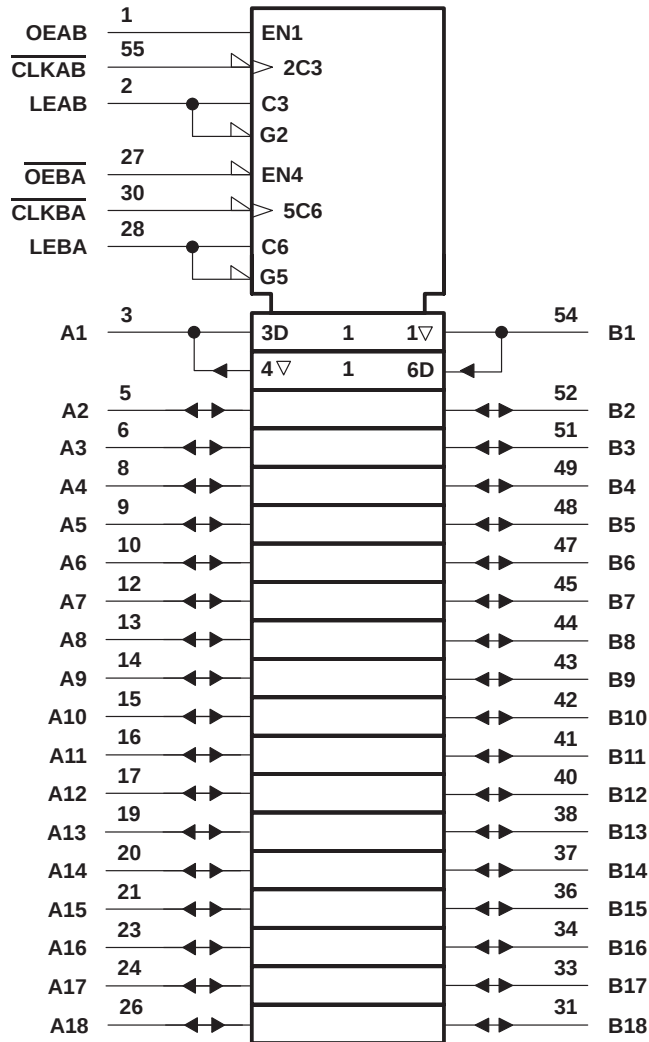
[‡] Output level before the indicated steady-state input conditions were established

[§] Output level before the indicated steady-state input conditions were established, provided that CLKAB was low before LEAB went low

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logic symbol[†]



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

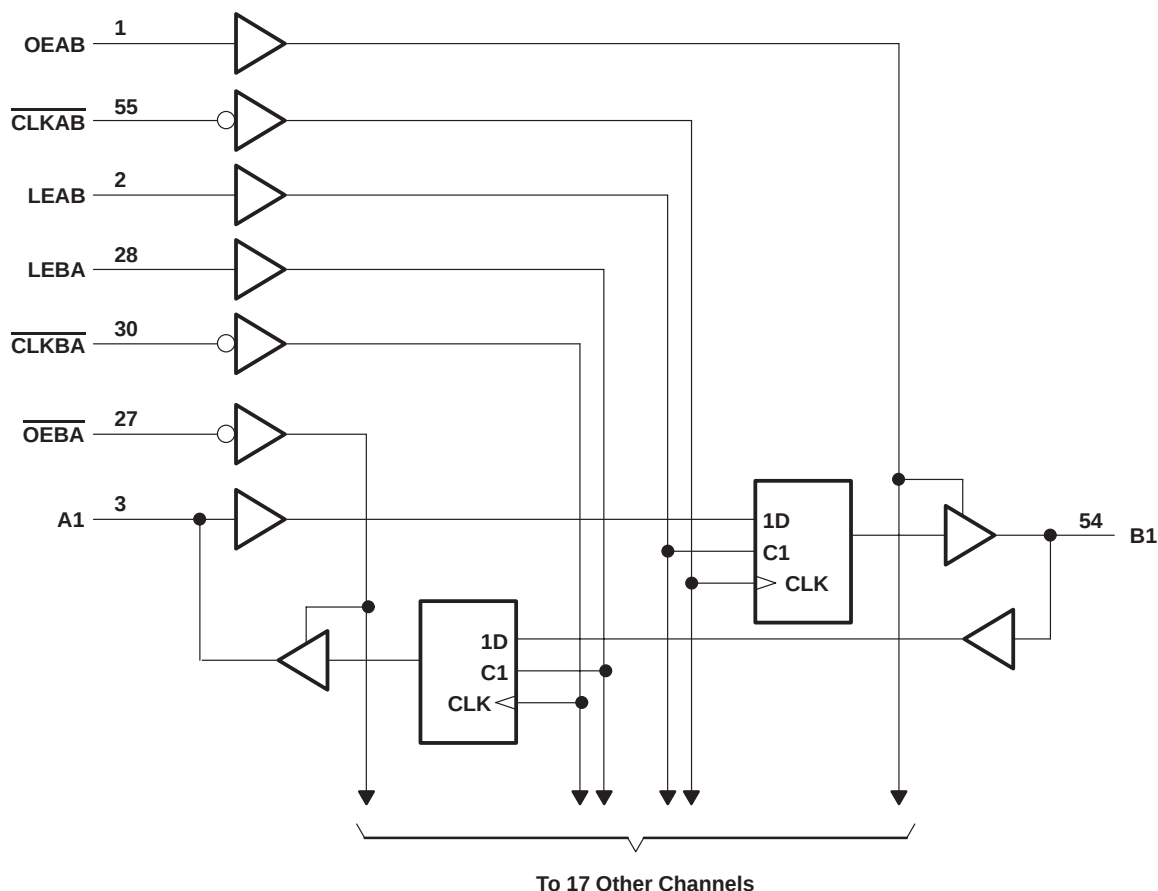
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logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC}	–0.5 V to 7 V
Input voltage range, V_I (except I/O ports) (see Note 1)	–0.5 V to 7 V
Voltage range applied to any output in the high or power-off state, V_O	–0.5 V to 5.5 V
Current into any output in the low state, I_O : SN54ABT16500B	96 mA
SN74ABT16500B	128 mA
Input clamp current, I_{IK} ($V_I < 0$)	–18 mA
Output clamp current, I_{OK} ($V_O < 0$)	–50 mA
Package thermal impedance, θ_{JA} (see Note 2): DGG package	81°C/W
DL package	74°C/W
Storage temperature range, T_{stg}	–65°C to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
2. The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51.

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recommended operating conditions (see Note 3)

			SN54ABT16500B		SN74ABT16500B		UNIT
			MIN	MAX	MIN	MAX	
V_{CC}	Supply voltage		4.5	5.5	4.5	5.5	V
V_{IH}	High-level input voltage		2		2		V
V_{IL}	Low-level input voltage			0.8		0.8	V
V_I	Input voltage		0	V_{CC}	0	V_{CC}	V
I_{OH}	High-level output current			–24		–32	mA
I_{OL}	Low-level output current			48		64	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	Outputs enabled		10		10	ns/V
$\Delta t/\Delta V_{CC}$	Power-up ramp rate		200		200		μ s/V
T_A	Operating free-air temperature		–55	125	–40	85	°C

NOTE 3: Unused pins (input or I/O) must be held high or low to prevent them from floating.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		TA = 25°C			SN54ABT16500B		SN74ABT16500B		UNIT	
				MIN	TYP†	MAX	MIN	MAX	MIN	MAX		
VIK		VCC = 4.5 V, II = -18 mA		-1.2			-1.2		-1.2		V	
VOH		VCC = 4.5 V, IOH = -3 mA		2.5			2.5		2.5		V	
		VCC = 5 V, IOH = -3 mA		3			3		3			
		VCC = 4.5 V		IOH = -24 mA			2					
				IOH = -32 mA			2*			2		
VOL		VCC = 4.5 V		IOL = 48 mA		0.55			0.55		V	
				IOL = 64 mA		0.55*			0.55			
Vhys				100							mV	
Ioff		VCC = 0, VI or VO ≤ 4.5 V		±100					±100		μA	
ICEX		VCC = 5.5 V, VO = 5.5 V	Outputs high	50			50		50		μA	
II	Control inputs	VCC = 0 to 5.5 V, VI = VCC or GND			±1			±1		±1		μA
	A or B ports	VCC = 2.1 V to 5.5 V, VI = VCC or GND			±20			±20		±20		
IO‡		VCC = 5.5 V, VO = 2.5 V		-50	-100	-180	-50	-180	-50	-180	mA	
IOZPU§		VCC = 0 to 2.1 V, VO = 0.5 V to 2.7 V, OE or OE = X		±50			±50		±50		μA	
IOZPD§		VCC = 2.1 V to 0, VO = 0.5 V to 2.7 V, OE or OE = X		±50			±50		±50		μA	
IOZH¶		VCC = 2.1 V to 5.5 V, VO = 2.7 V, OE ≥ 2 V, OE ≤ 0.8 V#		10			10		10		μA	
IOZL¶		VCC = 2.1 V to 5.5 V, VO = 0.5 V, OE ≥ 2 V, OE ≤ 0.8 V#		-10			-10		-10		μA	
ICC	A or B ports	VCC = 5.5 V, IO = 0, VI = VCC or GND		Outputs high		3		3		3		mA
				Outputs low		36		36		36		
				Outputs disabled		3		3		3		
ΔICC		VCC = 5.5 V, One input at 3.4 V, Other inputs at VCC or GND		50			50		50		μA	
Ci	Control inputs	VI = 2.5 V or 0.5 V		3							pF	
Cio	A or B ports	VO = 2.5 V or 0.5 V		9							pF	

* On products compliant to MIL-PRF-38535, this parameter does not apply.

† All typical values are at V_{CC} = 5 V.

‡ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

§ This parameter is characterized, but not production tested.

¶ The parameters I_{OZH} and I_{OZL} include the input leakage current.

For V_{CC} between 2.1 V and 4 V, OE should be less than or equal to 0.5 V to ensure a low state.

|| This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

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timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

			SN54ABT16500B		SN74ABT16500B		UNIT
			MIN	MAX	MIN	MAX	
f_{clock}	Clock frequency		0	150	0	150	MHz
$t_w^\dagger$	Pulse duration	LEAB or LEBA high	2.5		2.5		ns
		CLKAB or CLKBA high or low	3		3		
t_{su}	Setup time	A before CLKAB↓	3		3		ns
		B before CLKBA↓	3		3		
		A before LEAB↓ or B before LEBA↓	CLK high	1	1		
			CLK low	2.5	2.5		
t_h	Hold time	A after CLKAB↓ or B after CLKBA↓	0		0		ns
		A after LEAB↓ or B after LEBA↓	2		2		

[†] This parameter is characterized, but not production tested.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50$ pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 5$ V, $T_A = 25^\circ\text{C}$			SN54ABT16500B		SN74ABT16500B		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
f_{max}			150	200		150		150		MHz
t_{PLH}	A or B	B or A	1	2.5	3.6	1	4.2	1	4	ns
t_{PHL}			1	3.2	4.5	1	5.1	1	4.9	
t_{PLH}	LEAB or LEBA	B or A	1	3.2	4.5	1	5.6	1	5	ns
t_{PHL}			1	3.4	4.5	1	5.4	1	5	
t_{PLH}	CLKAB or CLKBA	B or A	1	3.5	4.7	1	5.4	1	5.3	ns
t_{PHL}			1	3.5	4.7	1	5.4	1	5.3	
t_{PZH}	OEAB or OEBA	B or A	1	3.4	4.6	1	5.3	1	5.1	ns
t_{PZL}			1.5	3.8	4.7	1.5	5.6	1.5	5.4	
t_{PHZ}	OEAB or OEBA	B or A	1.5	4.5	5.7	1.5	6.9	1.5	6.5	ns
t_{PLZ}			1.4	3.4	4.7	1.4	5.8	1.4	5.4	

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PARAMETER MEASUREMENT INFORMATION



LOAD CIRCUIT

TEST	S1
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	7 V
t_{PHZ}/t_{PZH}	Open



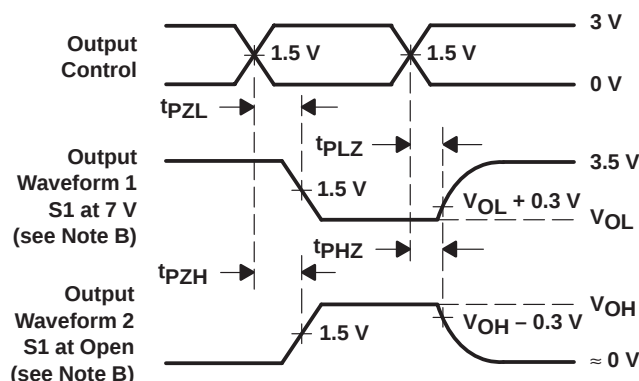
VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

- NOTES: A. C_L includes probe and jig capacitance.
- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r \leq 2.5 \text{ ns}$, $t_f \leq 2.5 \text{ ns}$.
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

TAPE AND REEL INFORMATION



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ABT16500BDGGR	TSSOP	DGG	56	2000	330.0	24.4	8.6	15.6	1.8	12.0	24.0	Q1
SN74ABT16500BDLR	SSOP	DL	56	1000	330.0	32.4	11.35	18.67	3.1	16.0	32.0	Q1

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ABT16500BDGGR	TSSOP	DGG	56	2000	346.0	346.0	41.0
SN74ABT16500BDLR	SSOP	DL	56	1000	346.0	346.0	49.0

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